# **<u>MOSFET</u> – Power, N-Channel,** SUPERFET III, Easy Drive

# 650 V, 12 A, 260 m $\Omega$

### Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

### Features

- 700 V @  $T_J = 150^{\circ}C$
- Typ.  $R_{DS(on)} = 222 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 24 \text{ nC}$ )
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 248 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

### Applications

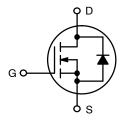
- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies
- Lighting / Charger / Adapter



# **ON Semiconductor®**

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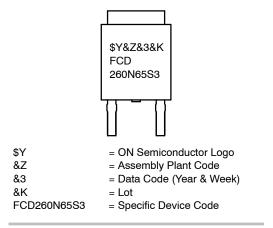
V <sub>DSS</sub> R <sub>DS(ON)</sub> MAX		I <sub>D</sub> MAX
650 V	260 mΩ @ 10 V	12 A



POWER MOSFET



### MARKING DIAGRAM



#### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Paran	Value	Unit		
V <sub>DSS</sub>	Drain to Source Voltage	650	V		
V <sub>GSS</sub>	Gate to Source Voltage	DC	±30	V	
		AC (f > 1 Hz)	±30	V	
Ι <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	12	А	
		Continuous (T <sub>C</sub> = 100°C)	7.6		
I <sub>DM</sub>	Drain Current	Pulsed (Note 1)	30	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		57	mJ	
I <sub>AS</sub>	Avalanche Current (Note 1)		2.3	A	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		0.9	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		20		
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	90	W	
		Derate Above 25°C	0.72	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		300	°C	

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 2.3 \text{ A}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}C$ . 3.  $I_{SD} \le 6 \text{ A}$ , di/dt  $\le 200 \text{ A}/\mu\text{s}$ ,  $V_{DD} \le 400 \text{ V}$ , starting  $T_J = 25^{\circ}C$ .

### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.39	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max. (Note 4)	40	

4. Device on 1 in<sup>2</sup> pad 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Reel Size	Tape Width	Shipping <sup>†</sup>
FCD260N65S3	FCD260N65S3	D-PAK	330 mm	16 mm	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS			•		
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650			V
		$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}}\!/\!\Delta\text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$	0.66			V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	1		1	μA
		$V_{DS}$ = 520 V, $T_{C}$ = 125°C		0.77		1
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V			±100	nA
N CHARACTE	ERISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 0.29 \text{ mA}$	2.5		4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6 \text{ A}$		222	260	mΩ
9fs	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 6 \text{ A}$		7.4		S
YNAMIC CHA	RACTERISTICS	•		•		
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz		1010		pF
Coss	Output Capacitance			25		pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		248		pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		33		pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 6 A, V <sub>GS</sub> = 10 V (Note 5)		24		nC
Q <sub>gs</sub>	Gate to Source Gate Charge			6.1		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			9.7		nC
ESR	Equivalent Series Resistance	f = 1 MHz				Ω
WITCHING CH	IARACTERISTICS		-	-	-	
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 6 \text{ A},$		18		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 5)		18		ns
t <sub>d(off)</sub>	Turn-Off Delay Time			49		ns
t <sub>f</sub>	Turn-Off Fall Time			12		ns
OURCE-DRAI	N DIODE CHARACTERISTICS		-	-	-	-
I <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current				12	Α
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current				30	Α
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 6 A			1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

 $\label{eq:VDD} \begin{array}{l} V_{DD} = 400 \; V, \; I_{SD} = 6 \; A, \\ dI_F/dt = 100 \; A/\mu s \end{array}$ 

251

3.4

ns

μC

5. Essentially independent of operating temperature typical characteristics.

**Reverse Recovery Time** 

Reverse Recovery Charge

t<sub>rr</sub>

Qrr

### **TYPICAL PERFORMANCE CHARACTERISTICS**

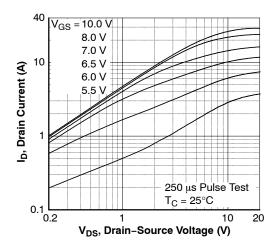
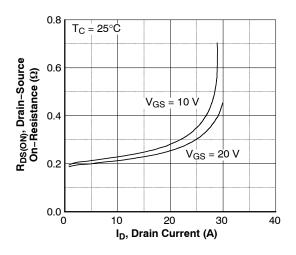
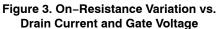


Figure 1. On–Region Characteristics





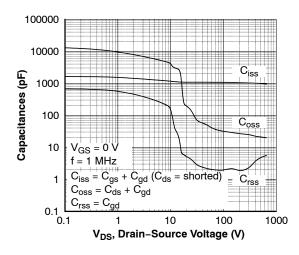


Figure 5. Capacitance Characteristics

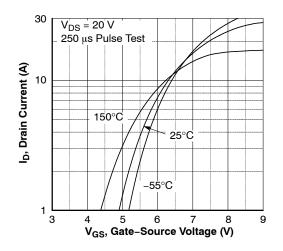
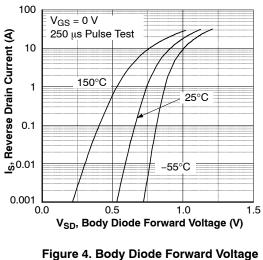
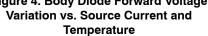


Figure 2. Transfer Characteristics





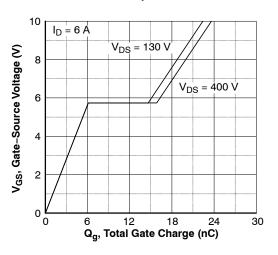
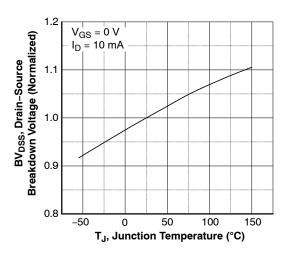


Figure 6. Gate Charge Characteristics

### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





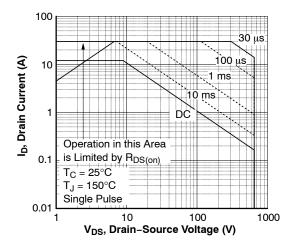


Figure 9. Maximum Safe Operating Area

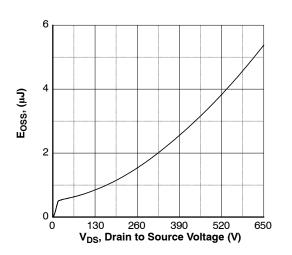


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

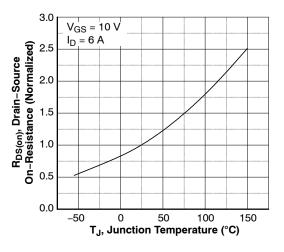


Figure 8. On–Resistance Variation vs. Temperature

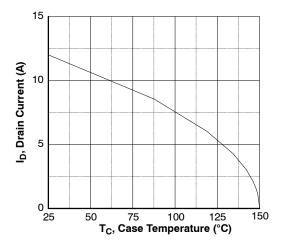


Figure 10. Maximum Drain Current vs. Case Temperature

### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

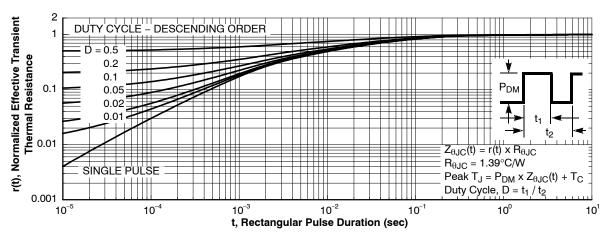
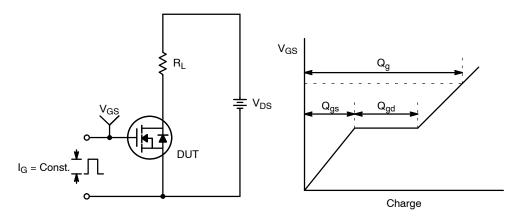


Figure 12. Transient Thermal Response Curve





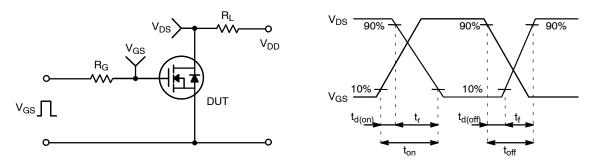
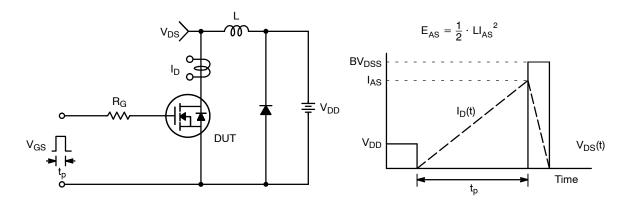


Figure 14. Resistive Switching Test Circuit & Waveforms





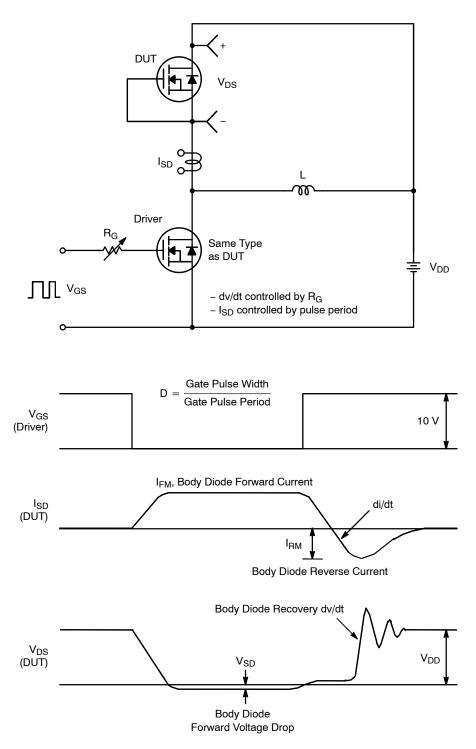
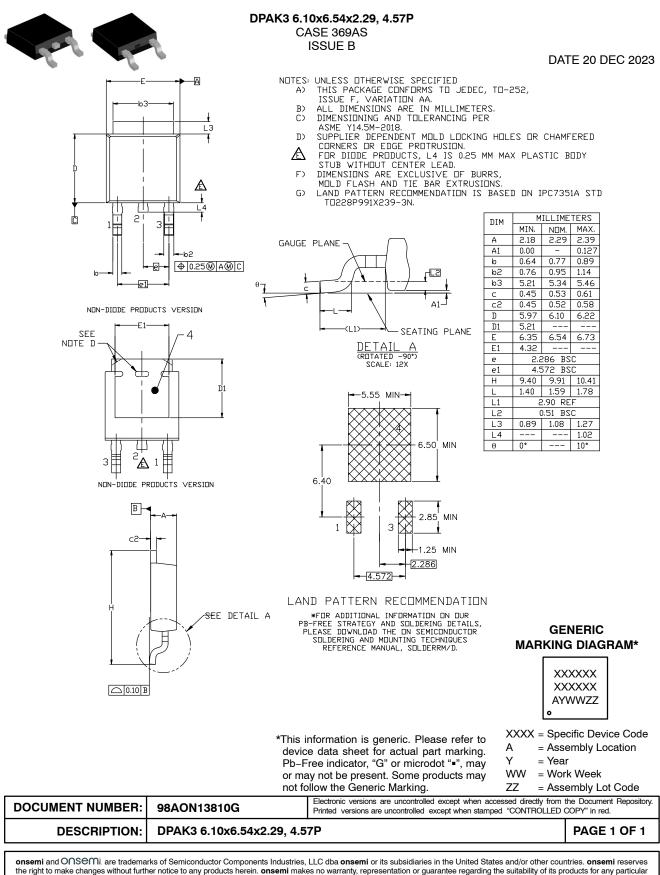


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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